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Part Number: [0432028911](#)
Status: **Active**
Overview: [modular_plugs_jacks](#)
Description: Modular Jack, Right Angle, Low Profile, Shielded, All Panel Grounding Tabs, with Bottom Grounding Tab, Rear Position PCB Ground Tab, 8/10

Documents:

3D Model	Product Specification PS-43202-001 (PDF)
Drawing (PDF)	RoHS Certificate of Compliance (PDF)

Agency Certification

CSA	LR19980
UL	E107635

General

Product Family	Modular Jacks/Plugs
Series	43202
Comments	Enhanced panel grounding tabs
Component Type	PCB Jack
Magnetic	No
Overview	modular_plugs_jacks
Performance Category	3
Power over Ethernet (PoE)	N/A
Product Name	RJ45

Physical

Color - Resin	Black
Durability (mating cycles max)	500
Flammability	94V-0
Inverted / Top Latch	No
Lightpipes/LEDs	None
Material - Metal	Brass, Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Orientation	Right Angle (Side Entry)
PCB Retention	Yes
PCB Thickness Recommended (in)	0.062 In
PCB Thickness Recommended (mm)	1.60 mm
Packaging Type	Tray
Pitch - Mating Interface (in)	0.050 In
Pitch - Mating Interface (mm)	1.27 mm
Plating min: Mating (µin)	50
Plating min: Mating (µm)	1.25
Plating min: Termination (µin)	100
Plating min: Termination (µm)	2.5
Ports	1
Positions / Loaded Contacts	8/10
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-40°C to +85°C
Termination Interface: Style	Through Hole
Wire/Cable Type	N/A

Electrical

Current - Maximum per Contact	1.5A
Grounding to PCB	Yes

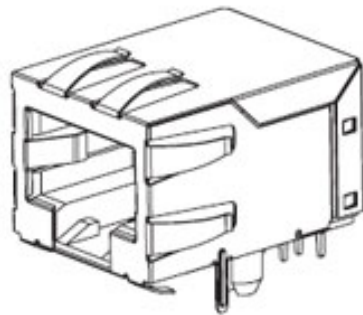


image - Reference only

Series

EU RoHS

**ELV and RoHS
Compliant**
REACH SVHC
Contains SVHC: No
Halogen-Free
Status

Not Reviewed

**Need more information on product
environmental compliance?**

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

Please visit the [Contact Us](#) section for any
non-product compliance questions.

China RoHS



Search Parts in this Series

[43202Series](#)

Mates With

FCC 68 Plugs

Grounding to Panel	Yes
Shielded	Yes
Voltage - Maximum	125V

Solder Process Data

Lead-free Process Capability	Wave Capable (TH only)
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Material Info

Reference - Drawing Numbers

Packaging Specification	PK-43202-004
Product Specification	PS-43202-001, RPS-43202-002
Sales Drawing	SDA-43202

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NOTES:

1) MATERIAL:

HOUSING: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
INSULATOR: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
TERMINALS: PHOSPHOR BRONZE, .012/ 0.30 THICK
SHIELD: BRASS, .007/ 0.18 THICK

2) FINISH:

TERMINALS:

A = SELECT GOLD IN CONTACT AREA: 50 MICROINCHES / 1.27 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
B = SELECT GOLD IN CONTACT AREA: 30 MICROINCHES / 0.76 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS AND/OR SHIELD.

SHIELD:

100 MICROINCHES / 2.54 MICROMETERS NICKEL OVER 50 MICROINCHES / 1.27
MICROMETERS COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN

3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43202.

4) PACKAGING SPECIFICATION:

UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-003.
UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN TUBES
PER MOLEX PACKAGING SPECIFICATION PK-43202-005.
SHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-004.

5) SEE SHEETS 7 - 9 FOR P.C. BOARD LAYOUTS.

6) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.

7) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.



SHIELDED MODULAR JACK
SHOWN WITH PANEL GROUND
OPTION 'D' AND FRONT
PCB GROUND TABS.

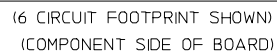
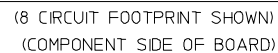
DRAWING LEGEND

SHEET 1- NOTES, DRAWING LEGEND
SHEET 2- SHIELDED MODULAR JACK W/ BOTTOM GROUND TABS
SHEET 3- SHIELDED MODULAR JACK W/O BOTTOM GROUND TABS
SHEET 4- UNSHIELDED MODULAR JACK
SHEET 5- PART NUMBER CHARTS
SHEET 6- PART NUMBER CHARTS
SHEET 7- FOOTPRINT LAYOUT FOR 4 POSITION HOUSING
SHEET 8- FOOTPRINT LAYOUT FOR 6 POSITION HOUSING
SHEET 9- FOOTPRINT LAYOUT FOR 8 POSITION HOUSING

OBS COLORED JACKS EC NO: UCP2008-1189 DRAWN:JBELL 2007/11/30 CHKD:LSCHMIDT 2008/02/20 APPR:FSM/TH 2008/03/04	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION
					mm	INCH	DRAWN BY JTR	DATE 1993/03/31	TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY MOLEX INCORPORATED	
				4 PLACES	± ---	± ---	CHECKED BY JTR	DATE 1993/03/31		
				3 PLACES	± ---	± .010				
				2 PLACES	± 0.25	± .014				
				1 PLACE	± 0.36	± ---				
				ANGULAR ±1/2°			APPROVED BY RAS	DATE 1993/03/31	DOCUMENT NO. SDA-43202	SHEET NO. 1 OF 9
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			MATERIAL NO. SEE SHTS 5&6			
				SIZE THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						

9	L2
8	L2
7	L2
6	L4
5	L
4	K2
3	L1
2	L1
1	L4
SH	REV

	13	12	11	10	9	8	7	6	5	4	3	2	43202		
J	SHIELDED MODULAR JACKS W/BOTTOM GROUND TABS (SHEET 2)														J
	ASSEMBLY MATERIAL NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	SIDE/TOP PANEL GROUND TAB OPTION	PCB GROUND TAB OPTION	TERMINAL PLATING OPTION	PACKAGING OPTION	HOUSING COLOR							
I	43202-8900	8	10	A	FRONT POSITION	A	TRAY	BLACK							
	43202-8901	8	10	B	FRONT POSITION	A	TRAY								
	43202-8902	8	10	C	FRONT POSITION	A	TRAY								
	43202-8903	8	10	D	FRONT POSITION	A	TRAY								
	43202-8908	8	10	A	REAR POSITION	A	TRAY								
H	43202-8909	8	10	B	REAR POSITION	A	TRAY								
	43202-8910	8	10	C	REAR POSITION	A	TRAY								
	43202-8911	8	10	D	REAR POSITION	A	TRAY								
	43202-8916	8	8	A	FRONT POSITION	A	TRAY								
	43202-8917	8	8	B	FRONT POSITION	A	TRAY								
G	43202-8918	8	8	C	FRONT POSITION	A	TRAY								
	43202-8919	8	8	D	FRONT POSITION	A	TRAY								
	43202-8924	8	8	A	REAR POSITION	A	TRAY								
	43202-8925	8	8	B	REAR POSITION	A	TRAY								
	43202-8926	8	8	C	REAR POSITION	A	TRAY								
	43202-8927	8	8	D	REAR POSITION	A	TRAY								
F														F	
E														E	
D														D	
C														C	
B														B	
A														A	
SEE SHEET 1 EC NO: UCP2004-1347 DRWN:MKAMARA0004/02/09 CHKD:MKAMARA0004/02/09 APPR:BMWKUS 2004/02/10 QUALITY SYMBOLS ▽ - 0 ▽ - 0 DESCRIPTION GENERAL TOLERANCES (UNLESS SPECIFIED) mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± .010 2 PLACES ± 0.25 ± .014 1 PLACE ± 0.36 ± --- ANGULAR ±1/2° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS SCALE 4:1 DESIGN UNITS INCH DIMENSION STYLE IN/MM DRAWN BY JTR DATE 1993/03/18 CHECKED BY JTR DATE 1993/03/18 APPROVED BY RAS DATE 1993/03/18 THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION THIRD ANGLE PROJECTION TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY MOLEX INCORPORATED MATERIAL NO. SEE CHART DOCUMENT NO. SDA-43202 SHEET NO. 5 OF 9 REVISE ON CAD ONLY															
1b_frame_C_P_ME_T Rev. C 2002/05/05	12	11	10	9	8	7	6	5	4	3	2	1			



NOTES:
1. RECOMMENDED PCB THICKNESS: .062±.005/(1.57±0.13)

ADD PCB THICKNESS

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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